

Features

- ◆ Voltage : 30 volts
- ◆ High peak reverse power dissipation
- ◆ High reliability
- ◆ Low leakage current
- ◆ Standard zener voltage tolerance is $\pm 5\%$.

Mechanical Data

Case : Molded plastic body

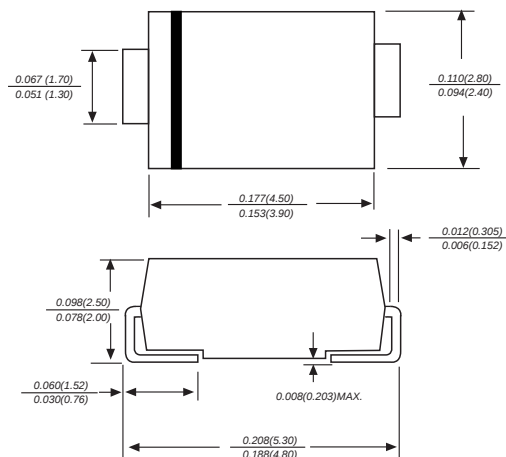
Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0023 ounce, 0.07 grams

DO-214AC/SMA



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

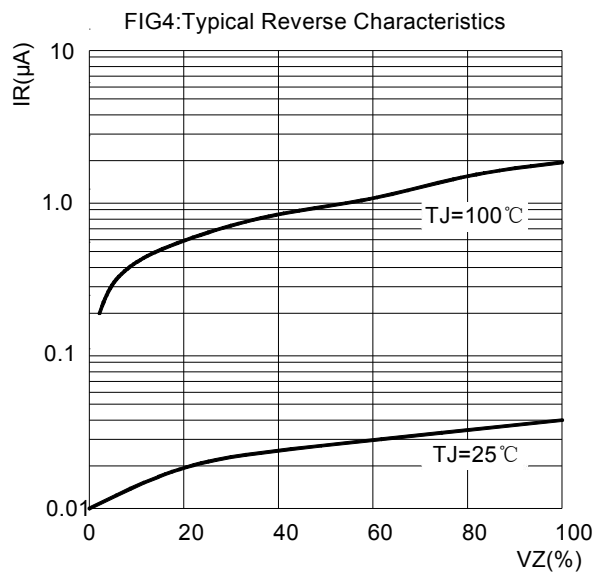
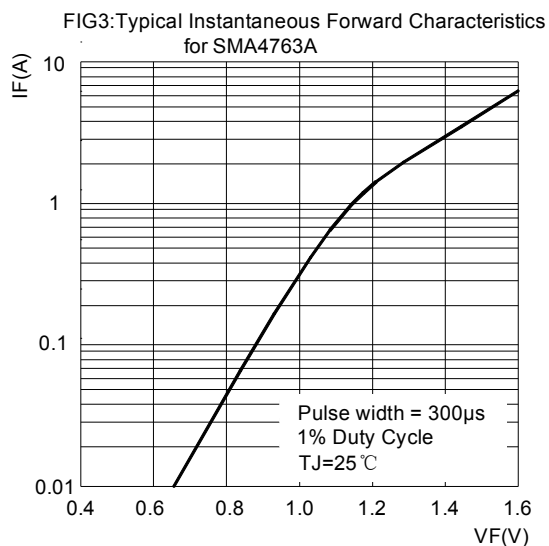
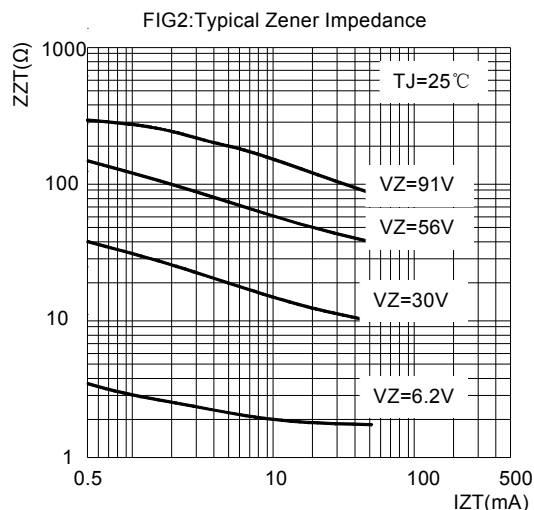
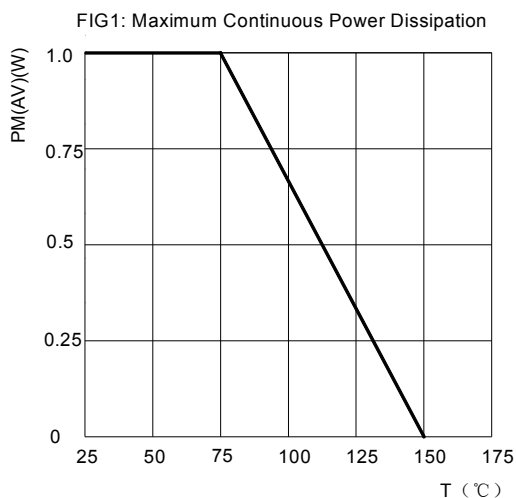
Rating	Symbol	Value	Unit
DC Power Dissipation at $T_L = 75^\circ\text{C}$ (Note1)	P_D	1.0	W
Maximum Forward Voltage at $I_F = 200\text{ mA}$	V_F	1.2	V
Junction Temperature Range	T_J	- 55 to + 150	$^\circ\text{C}$
Storage Temperature Range	T_S	- 55 to + 150	$^\circ\text{C}$

Device	Marking	Nominal Zener Voltage		Maximum Zener Impedance			Maximum Reverse Leakage Current		Maximum DC Zener Current	Maximum Surge Current
		$V_Z @ I_{ZT}$	I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK}$	I_{ZK}	$I_R @ V_R$		I_{ZM}	$I_{RM}^{(2)}$
		(V)	(mA)	(Ω)	(Ω)	(mA)	(μA)	(V)	(mA)	(mA _{pk})
SMAZ30-TP-CN	751A	30	8.5	40	1000	0.25	5.0	22.8	30	150

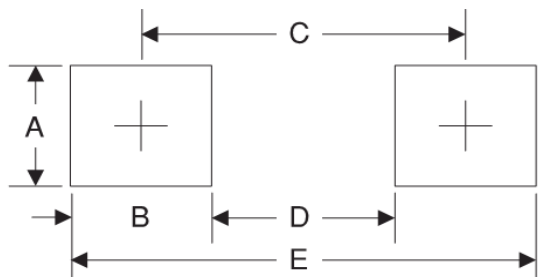
Notes :

- (1) The type number listed have a standard tolerance on the nominal zener voltage of $\pm 5\%$.
- (2) The reverse surge current is a non-repetitive, 8.3ms pulse width square wave or equivalent sine-wave superimposed on I_{ZT} per JEDEC Method

Ratings And Characteristic Curves

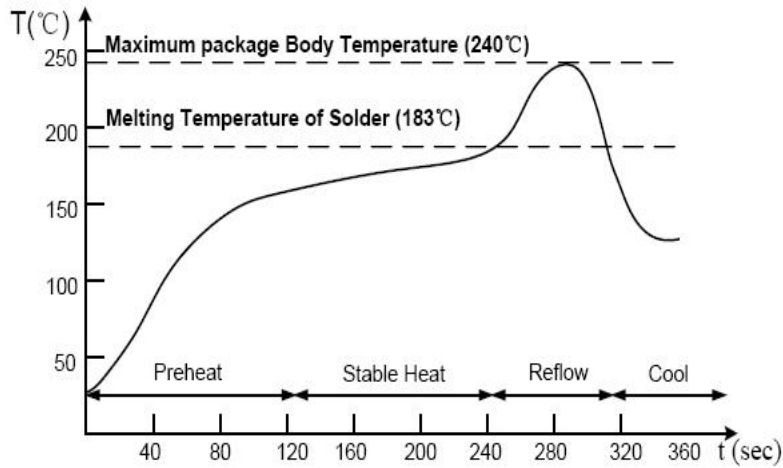


Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
B	1.52	0.060
C	3.90	0.154
D	2.41	0.095
E	5.45	0.215

Suggested Soldering Temperature Profile

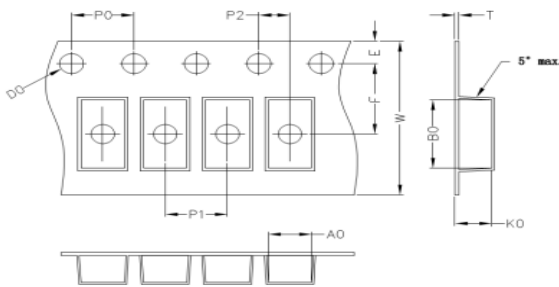


Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
2.80	5.30	2.36	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	4.0	2.0	0.25	12	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMA	11'	278	5	285	10	355*310*310	80

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